# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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## **SPECIFICATION**

- · Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- · Samsung P/N:
- CL05A106MP5NUNC

(Reference sheet)

- · Description :
- CAP, 10uF, 10V, ±20%, X5R, 0402

A. Samsung Part Number

			<u>CL</u> ①	<u>05</u> ②	<u>А</u> З	<u>106</u> ④	<u>M</u> 5	<u>Р</u> 6	<u>5</u> 7	<u>N</u> 8	<u>ป</u> 9	<u>N</u> 10	<u>С</u> Ш		
1	Series	Samsung Multi-layer Ceramic Capacitor													
2	Size	0402 (	inch c	ode)		L:	1.00	± 0.20	mm			W:	0.50 ± 0.20	mm	
3	Dielectric	X5R					8	Inner	elect	rode			Ni		
4	Capacitance	10 נ	ιF					Term	inatic	n			Cu		
5	Capacitance	±20 9	%					Platir	ng				Sn 100%	(Pb Free)	
	tolerance						9	Prod	uct				Size control	code	
6	Rated Voltage	10 \	/				10	Spec	ial				Reserved for	or future use	
1	Thickness	0.50 ± 0.2	20 mm				1	Pack	aging				Cardboard 7	Гуре, 7" reel	

#### B. Structure & Dimension



Samsung P/N	Dimension(mm)								
Samsung F/N	L	W	Т	BW					
CL05A106MP5NUNC	1.00 ± 0.20	0.50 ± 0.20	0.50 ± 0.20	0.25 ± 0.10					

#### C. Samsung Reliablility Test and Judgement Condition

Tan δ (DF)0Insulation10,ResistanceWith the second secon	000Mohm or 50Mohm× <i>μ</i> F hichever is smaller	1 kHz ±10% / 0.5±0.1Vrms*A capacitor prior to measuring the capacitance is heattreated at 150°C+0/-10°C for 1 hour and maintained inambient air for 24±2 hours.Rated Voltage60~120 sec.				
Insulation 10, Resistance W	000Mohm or 50Mohm× <i>μ</i> F hichever is smaller	treated at $150^{\circ}C+0/-10^{\circ}C$ for 1 hour and maintained in ambient air for 24±2 hours.				
Resistance W	hichever is smaller	Rated Voltage 60~120 sec.				
Appearance No	abnormal exterior appearance					
	abnormal exterior appearance	Microscope (×10)				
Withstanding No	dielectric breakdown or	250% of the rated voltage				
Voltage me	chanical breakdown					
Temperature X5	R					
Characteristics (Free	om-55℃ to 85℃, Capacitance change sho	ould be within ±15%)				
Adhesive Strength No	peeling shall be occur on the	500g·f, for 10±1 sec.				
of Termination terr	minal electrode					
Bending Strength Ca	pacitance change : within ±12.5%	Bending to the limit (1mm)				
		with 1.0mm/sec.				
Solderability Mo	re than 75% of terminal surface	SnAg3.0Cu0.5 solder				
is to	o be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120℃ for 10~30sec.)				
Resistance to Ca	pacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.				
¥	n δ, IR : initial spec.					
	n δ, IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)				
Moisture Ca		With rated voltage				
Resistance Tar	nδ: 0.25 max	40±2℃, 90~95%RH, 500+12/-0hrs				
IR	: 500Mohm or 3.5Mohm × $\mu$ F					
	Whichever is smaller					
High Temperature Ca	pacitance change : within ±12.5%	With 100% of the rated voltage				
		Max. operating temperature				
IR	: 1,000Mohm or 7Mohm × $\mu$ F	1000+48/-0hrs				
	Whichever is smaller					
Temperature Ca	pacitance change : within ±15%	1 cycle condition				
-		Min. operating temperature $\rightarrow 25^{\circ}C$				
		$\rightarrow$ Max. operating temperature $\rightarrow$ 25°C				
		5 cycle test				

X The reliability test condition can be replaced by the corresponding accelerated test condition.

#### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5°C, 10sec. Max )

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

### - Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury. We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- ④ Military equipment
- *⑤* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.